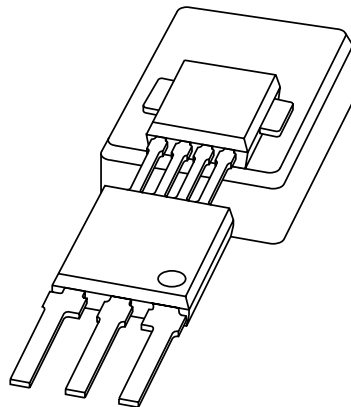


# DATA SHEET



## **KMI22/1**

Rotational speed sensor for  
extended air gap application and  
direction detection

Objective specification

2000 Sep 04

# Rotational speed sensor for extended air gap application and direction detection

KMI22/1

## FEATURES

- Digital current output signal
- Digital offset compensation
- Extended air gap
- Zero speed capability
- Direction detection
- Digital output protocol
- Three level output signal
- Additional digital input pin
- Wide temperature range
- Insensitive to vibration
- EMC resistant
- Tolerant to positioning.

## DESCRIPTION

The KMI22/1 is a sensitive rotational speed sensor for the application with ferrous gear wheels<sup>(1)</sup>. The sensor consists of a magnetoresistive sensor element, a driver IC in BIMOS technology, a digital signal conditioning IC in highly integrated CMOS technology and a ferrite magnet. The digital two wire current output carries a signal proportional to the rotational speed of a gear wheel plus a digital protocol.

CAUTION
Do not press two or more products together against their magnetic forces.

(1) The sensor contains customized integrated circuits. Usage in hydraulic brake systems and in systems with active brake control is forbidden. For all other applications, higher temperature versions of up to 150 °C are available on request.

## QUICK REFERENCE DATA

SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNIT
V <sub>CC</sub>	DC supply voltage	0	12	18	V
I <sub>CCL</sub>	current output signal low	5.6	7.0	8.4	mA
I <sub>CCPH</sub>	current output signal protocol high	11.2	14	16.8	mA
I <sub>CCSH</sub>	current output signal speed high	22.4	28	33.6	mA
V <sub>in</sub>	input voltage pin 2	0	–	100	% V <sub>CC</sub>
d	sensing distance	0 to 4	0 to 4.5	–	mm
f <sub>r</sub>	operating tooth frequency	0	–	2500	Hz
T <sub>amb</sub>	ambient operating temperature	–40	–	+85	°C

## PINNING

PIN	DESCRIPTION
1	V <sub>CC</sub>
2	V <sub>in</sub>
3	V–

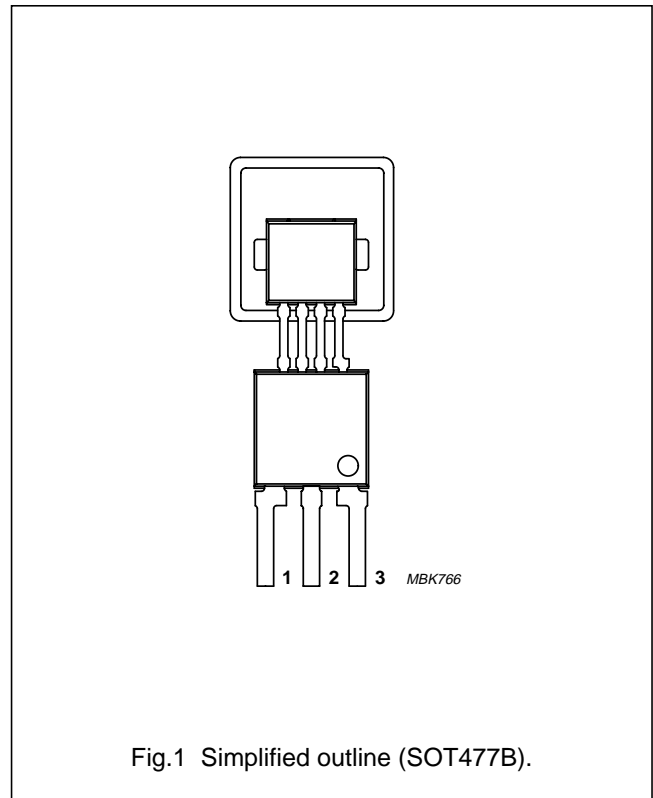


Fig.1 Simplified outline (SOT477B).

# Rotational speed sensor for extended air gap application and direction detection

KMI22/1

## LIMITING VALUES

In accordance to the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{CC}$	DC supply voltage between leads 1 + 3	$T_{amb} = -40$ to $+85$ °C; $R_L = 43$ Ω; see Fig.12	0	18	V
$V_{in}$	input voltage pin 2	$T_{amb} = -40$ to $+85$ °C	$V-$	$V_{CC}$	V
$T_{stg}$	storage temperature range		-65	+150	°C
$T_{amb}$	ambient operating temperature		-40	+85	°C
$T_{sld}$	soldering temperature	$t < 10$ s	-	260	°C
	output short-circuit duration	$V_{CC}$ to GND (see Fig.12)	continuous		
	short-circuit duration	pin 2 to pin 1 and pin 2 to pin 3	continuous		
	wrong polarity	$T_{amb} = -40$ to $+65$ °C; $R_L = 43$ Ω; note 1	continuous		

### Note

1. With  $R_L = 43$  Ω the device is continuously protected against wrong polarity of DC supply voltage ( $V_{CC}$ ) to GND; see Fig.12.

## CHARACTERISTICS

$T_{amb} = 25$  °C;  $V_{CC} = 12$  V;  $d = 2.1$  mm;  $f_t = 2$  kHz; test circuit: see Fig.12;  $R_L = 43$  Ω; sensor positioning: see Fig.13; gear wheel: module 2 mm; material 1.0715; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$I_L$	current output low	$T = -40$ to $+85$ °C; see Figs 6 and 8	5.6	7	8.4	mA
$I_{PH}$	current output protocol high	$T = -40$ to $+85$ °C; see Figs 6 and 8;	11.2	14	16.8	mA
$I_{SH}$	current output speed high	$T = -40$ to $+85$ °C; see Figs 6 and 8;	22.4	28	33.6	mA
$t_r$	output signal rise time	$C_L = 100$ pF; 10 to 90% value	-	0.5	-	μs
$t_f$	output signal fall time	$C_L = 100$ pF; 90 to 10% value	-	0.5	-	μs
$f_t$	operating tooth frequency	for both rotation directions $T = -40$ to $+85$ °C	0	-	2500	Hz
$d_{in 0 Hz}$	sensing distance in initial mode for signals > 0 Hz	see Fig.13	0 to 2.5	0 to 2.9	-	mm
$d_{in 1 Hz}$	sensing distance in initial mode for signals > 1 Hz	see Fig.13	0 to 3.5	0 to 3.9	-	mm
$d_{dir}$	sensing distance for safe direction detection	see Fig.13	0 to 3	0 to 3.4	-	mm
$d_{act}$	sensing distance in active mode	see Fig.13	0 to 4	0 to 4.5	-	mm
$\delta_{in 0 Hz}$	duty cycle in initial mode for signals > 0 Hz	$T = -40$ to $+85$ °C; see Fig.5	20	50	80	%
$\delta_{in 1 Hz}$	duty cycle in initial mode for signals > 1 Hz	$T = -40$ to $+85$ °C; see Fig.5	20	50	80	%
$\delta_{act}$	duty cycle in active mode	$T = -40$ to $+85$ °C; see Fig.5	40	50	60	%

# Rotational speed sensor for extended air gap application and direction detection

KMI22/1

## FUNCTIONAL DESCRIPTION

The KMI22/1 is sensitive to the motion of ferrous gear wheels. The functional principle is shown in Fig.3. Due to the effect of flux bending the different directions of magnetic field lines in the magneto-resistive sensor element will cause an electrical signal. Because of the chosen sensor orientation and the direction of ferrite magnetization the KMI22/1 is sensitive to movement in the 'y' direction in front of the sensor only (see Fig.2).

The KMI22/1 contains a magneto-resistive sensor element and two ICs: a Position Detector IC (PDIC) and a Line Driver IC (LDIC). The sensor signal is fed into the PDIC which converts the signal to the digital domain, applies digital compensation and additional processing. The LDIC contains three current sources (one constant, two switchable), a voltage control unit and a level shifter to provide the signal  $V_{in}$  to the PDIC (see Fig.4). The digital output from the device is the combination of the speed pulse and an 8-bit data protocol.

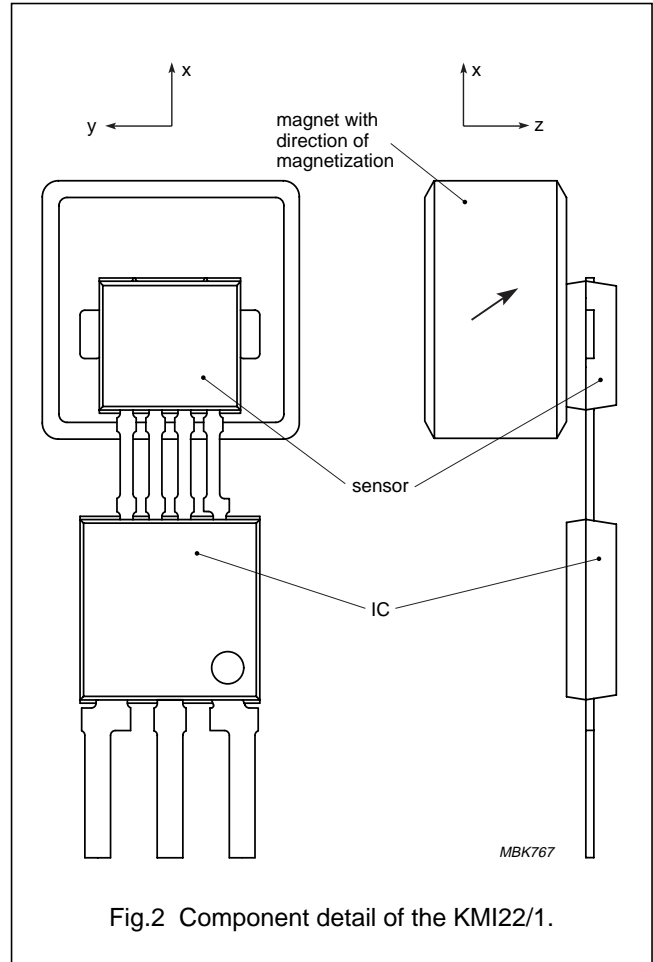


Fig.2 Component detail of the KMI22/1.

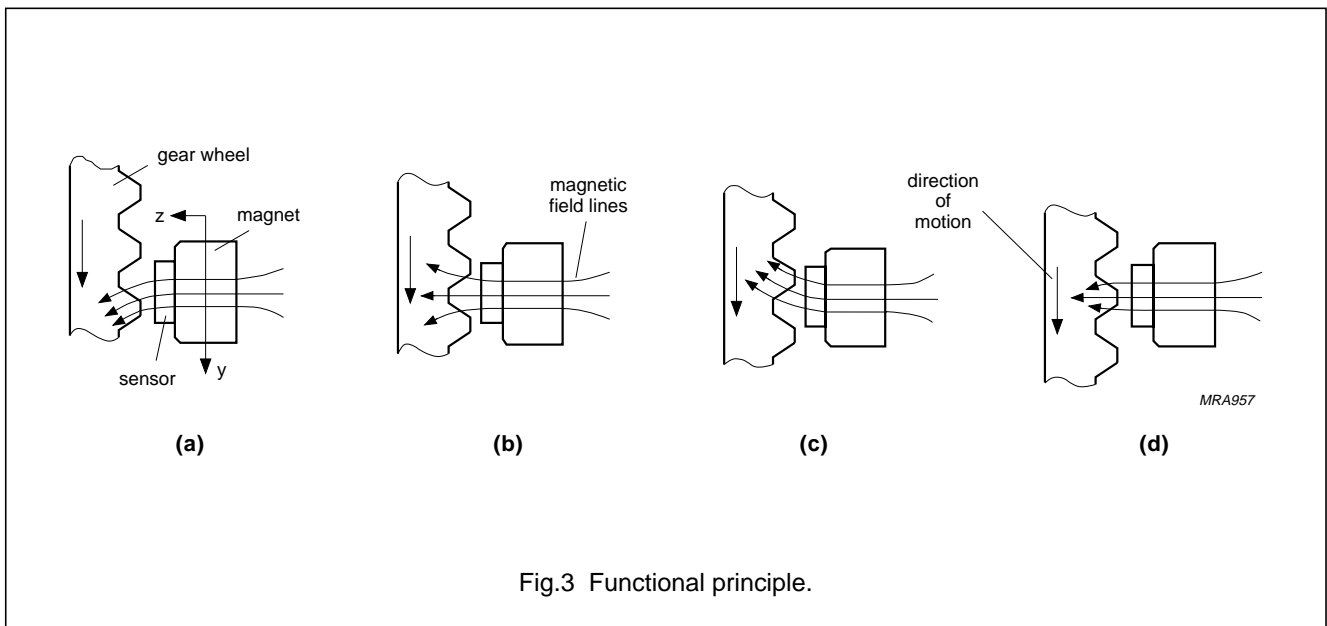


Fig.3 Functional principle.

Rotational speed sensor for extended air gap application and direction detection

KMI22/1

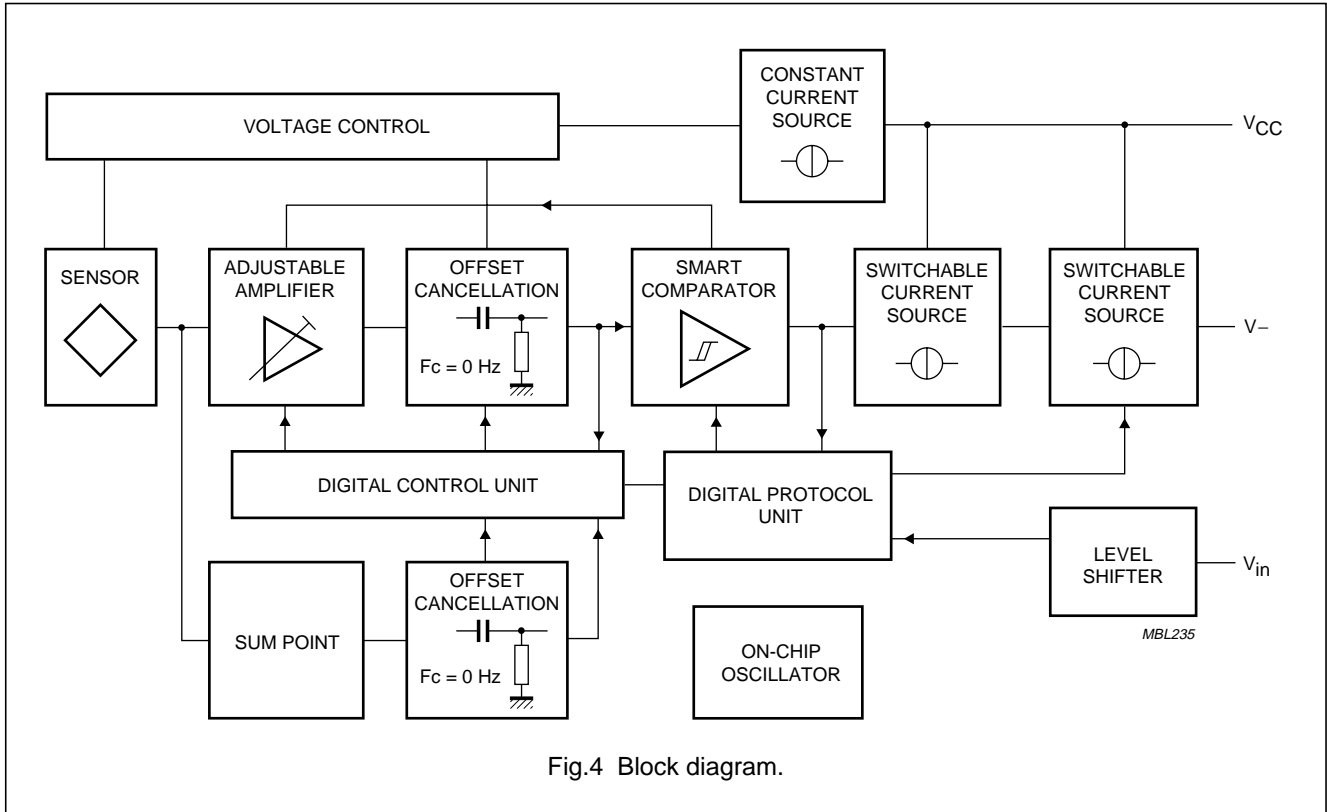
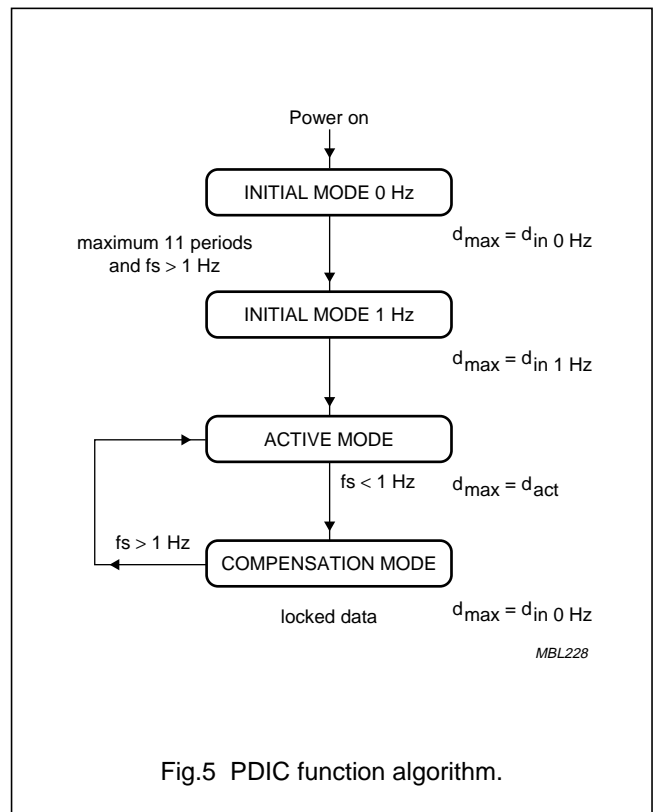


Figure 5 shows the digital compensation function in algorithmic format. After power on the sensor system is running in INITIAL MODE 0 Hz. The sensor signal is preamplified but not offset compensated. The output signal represents the specified sensing distances (see Chapter “Characteristics”) for every tooth of the wheel, totally speed independent.

When  $d_{in\ 0\ Hz} < d < d_{in\ 1\ Hz}$  the system must first detect the sensor signal amplitudes to compensate for the sensor offset INITIAL MODE 1 Hz. An output signal is produced (first compensation run finished) latest after 11 wheel teeth, with a frequency above 1 Hz have been sensed.

After detecting the teeth in initial mode the PDIC changes to the ACTIVE MODE and the sensor signal is permanently offset compensated. The available sensing distance is increased to  $d_{act}$ . Quitting ACTIVE MODE is caused by power off or by the teeth frequency falling below 1 Hz. The system is locked into COMPENSATION MODE and continues to detect every wheel tooth down to zero speed.



# Rotational speed sensor for extended air gap application and direction detection

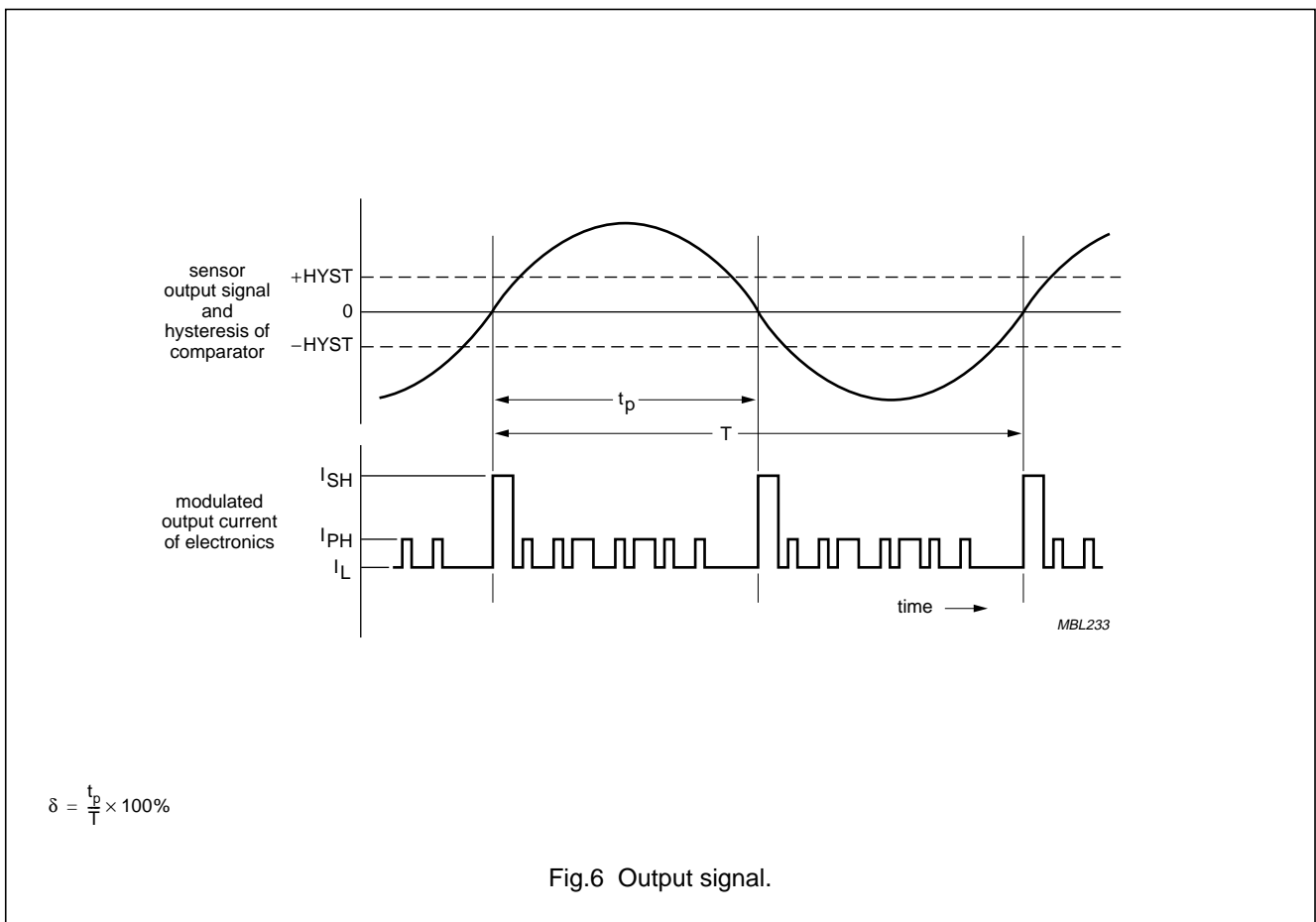
KMI22/1

## Output signal

The output signal is shown in Fig.6. The signal contains a speed signal and an 8-bit protocol following the speed signal. This serial transmission, using the Manchester Code to encode the bits, is realized by modulating the 3-level output current of the sensor system. A short pulse of the highest current level  $I_{SH}$  represents the gear wheel structure, whereas the protocol bits are coded by using the protocol current level  $I_{PH}$ .

## Definition of the protocol data bit value

Figure 7 shows the definition of the protocol data bit value. The protocol data bit has the bit length  $t_d$ . It is split into two half signal parts by the current edge in the middle of the data bit. Data bit HIGH is defined by the rising current edge from  $I_L$  to  $I_{PH}$ . Data bit LOW is defined by the falling current edge. Any data bit without a current edge at its middle is invalid.



# Rotational speed sensor for extended air gap application and direction detection

KMI22/1

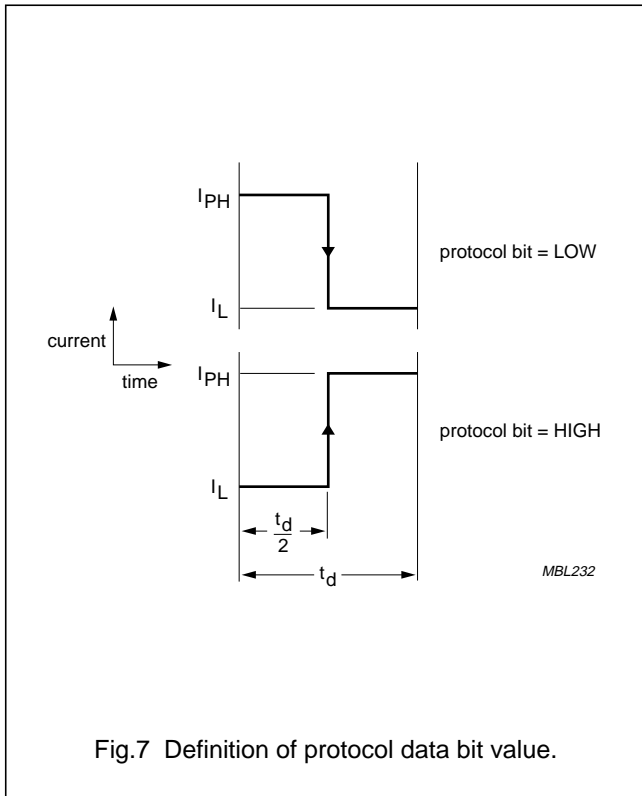


Fig.7 Definition of protocol data bit value.

### Timing of the data

The data timing is shown in Figs 8 and 9.

#### OPERATION AT NORMAL SPEED

The wheel speed pulse is generated whenever a rising or falling edge of the wheel signal is detected. The pulse length is  $t_s$ . Following the wheel speed pulse a pre-bit is sent. It is always low and has the length  $t_p$ .

After the pre-bit the sensor logic begins to transfer the data protocol bits. The data protocol transferred by the sensor logic consists of 9 data bits (8 data bits and a parity bit; see Table 3). The data bit is length  $t_d$  and must contain a current edge its middle.

Following the data protocol bits an end bit with length  $0.5 \times t_d$  is transferred. The end bit is always low, switching the current output to  $I_L$  until the arrival of the next wheel speed pulse leading edge.

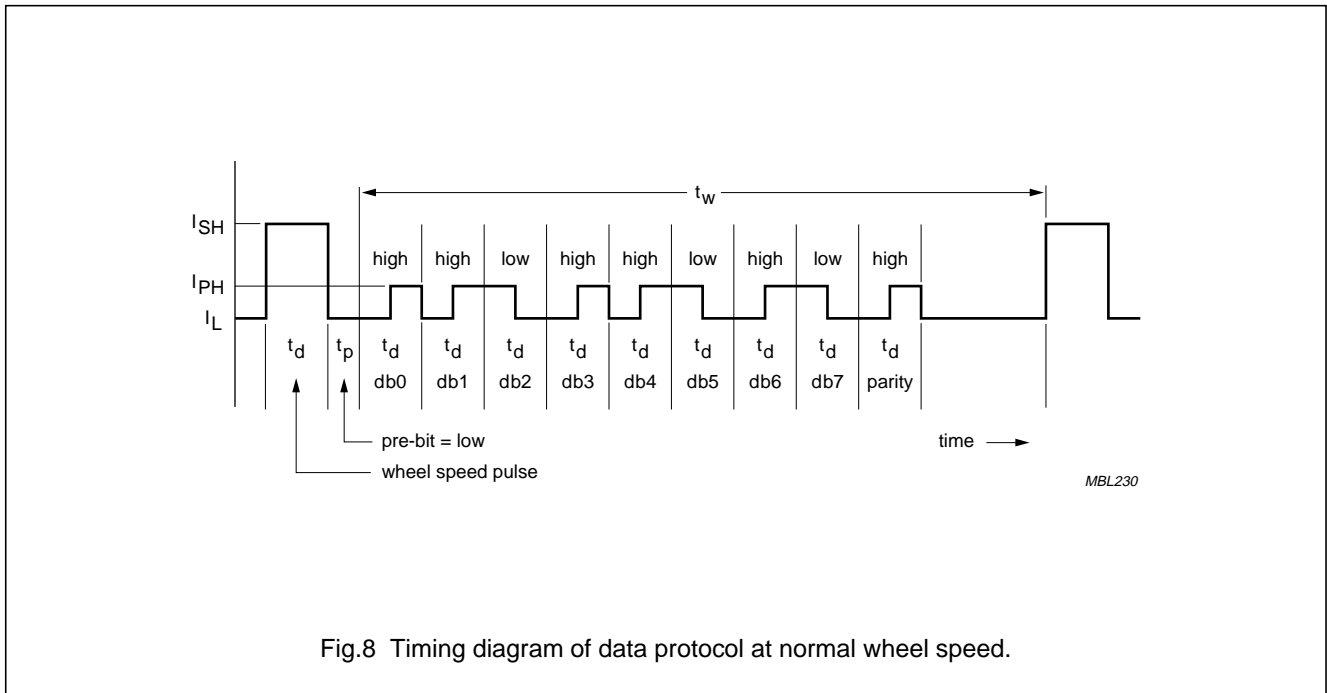


Fig.8 Timing diagram of data protocol at normal wheel speed.

# Rotational speed sensor for extended air gap application and direction detection

KMI22/1

## OPERATION AT VERY LOW SPEED

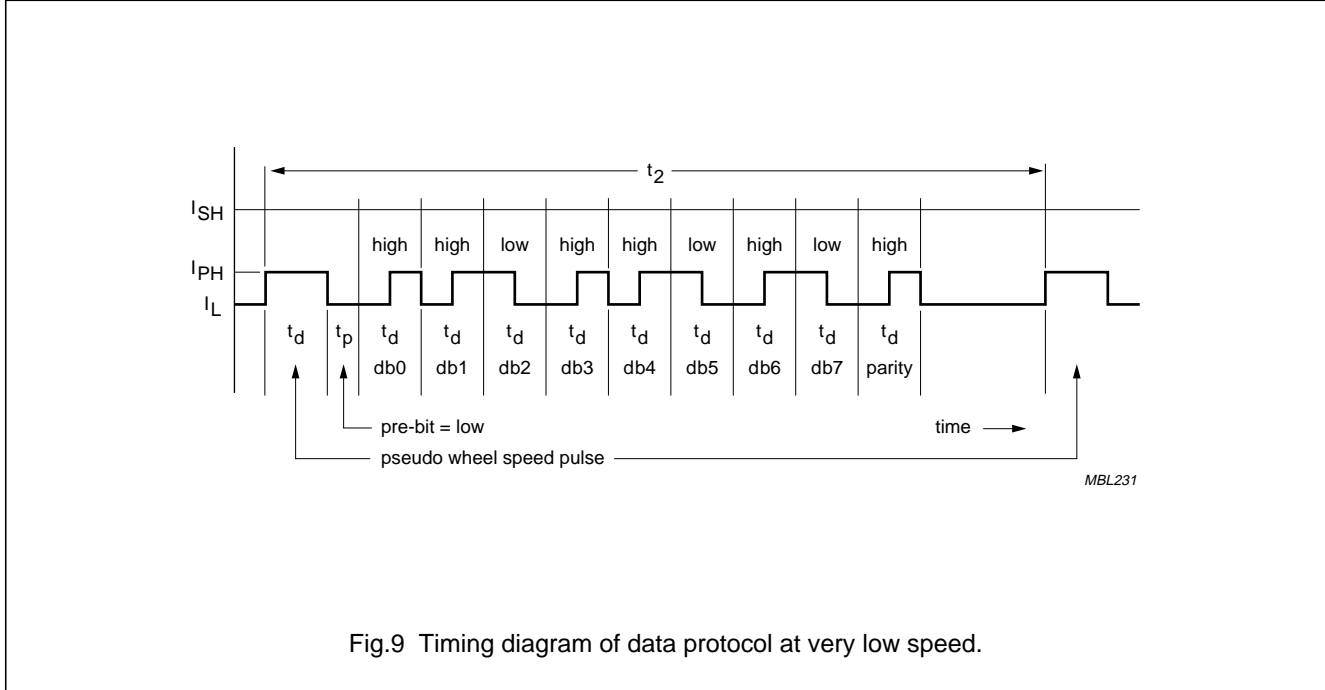


Fig.9 Timing diagram of data protocol at very low speed.

In the event that no wheel speed pulse is detected during time  $t_2$  the protocol transfer is executed as described previously, except that a pseudo wheel speed pulse with protocol level high of  $I_{PH}$  instead of  $I_{SH}$  is substituted for the wheel speed pulse (see Fig.9).

### TIMING AT HIGH SPEED

The pulse width of data bits  $t_d$  is fixed, whereas the time interval between wheel speed pulses is not. The higher the speed of the wheel, the shorter the period  $t_w$ , therefore not all data bits can be transferred at high wheel speed.

In this situation, calculations are made based on the current wheel speed pulse interval ( $n$ ) to determine how many will fit into this window. This data is then used to determine the number of data bits that will be transferred during the next wheel speed pulse interval ( $n + 2$ ), as shown in Table 1.

During time interval  $n + 2$  the sensor current output consists of the wheel speed pulse, pre-bit, data bits (less than 9 bits; see Table 1), and the end bit data.

Referring to Table 1 it can be seen that the minimum number of data bits that will be transferred during period  $n + 2$  is 2. If 3 or less data bits are to be transferred, the end bit length will be reduced to 0.

Table 1 Calculation of the number of protocol bits

MAXIMUM NUMBER OF $t_d$ IN THE CURRENT TIME INTERVAL $n$ ( $t_w$ )	PROTOCOL BITS FOR TIME INTERVAL $n + 2$
<5	2
5	3
6	4
7	5
8	6
9	7
10	8
>10	8



# Rotational speed sensor for extended air gap application and direction detection

KMI22/1

## PULSE AND PROTOCOL DEFINITIONS

**Table 2** Pulse and protocol timing

$T_{amb} = -40$  to  $+85$  °C;  $V_{CC} = 12$  V; test circuit: see Fig.12;  $R_L = 43$  Ω; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$t_s$	speed signal pulse width	see Figs 8 and 9	40	50	60	μs
$t_p$	pre-bit pulse width	see Figs 8 and 9	20	25	30	μs
$t_d$	data pulse width	see Figs 8 and 9	40	50	60	μs
$t_2$	time between pseudo speed pulses	see Fig.9	120	150	180	ms

**Table 3** Definition of data bits

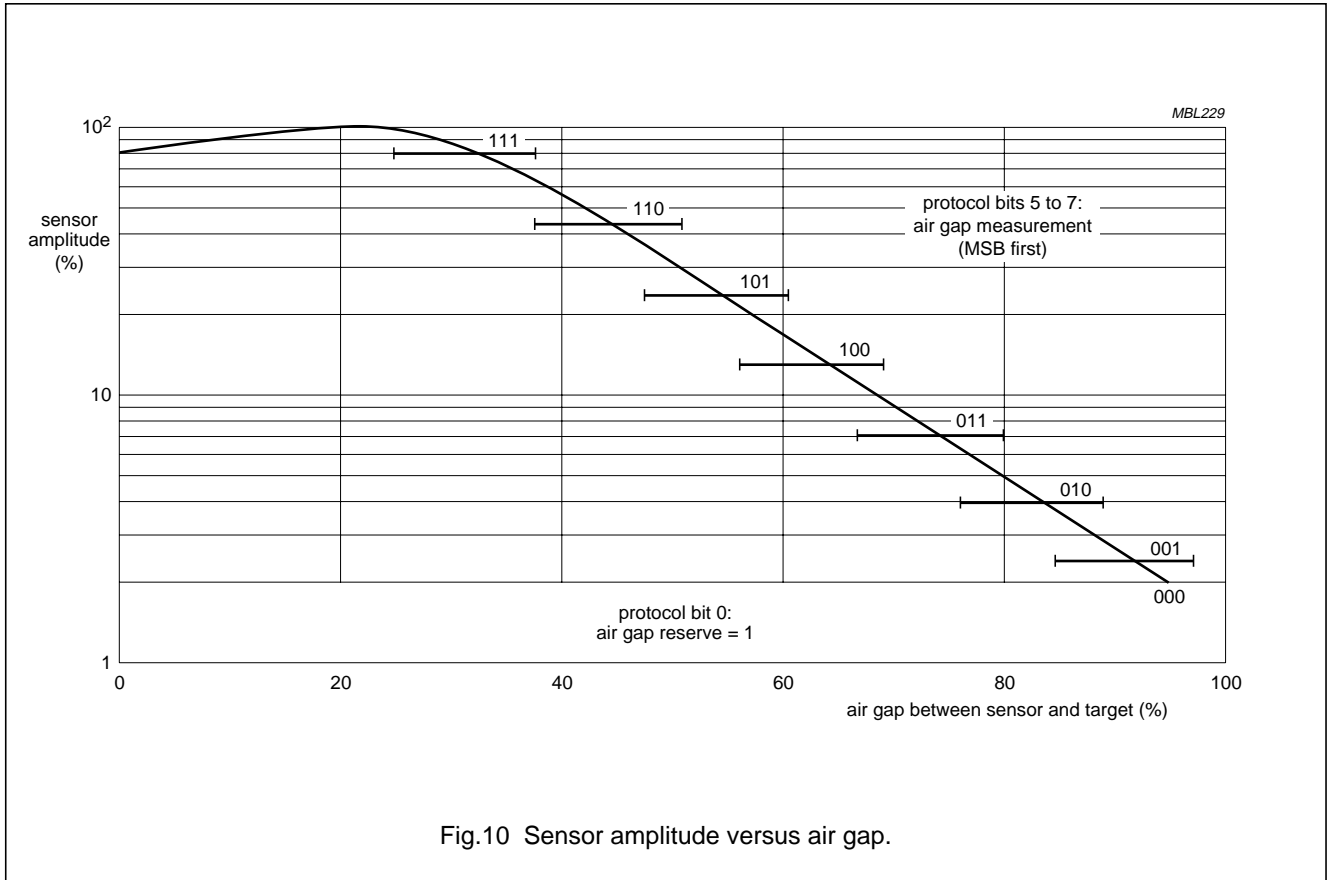
DATA BIT	SYMBOL	DESCRIPTION	REMARK
0	AR	air gap reserve	logic 1 when distance too large; note 1
1	M	mode state	logic 1 when in initial mode, 0 when in active mode
2	$V_{in}$	digital input state	logic 1 when $V_{in} =$ low; default
3	VDR	validity direction recognition	logic 1 when direction bit is valid; note 2
4	DR	direction recognition	logic 1 when direction is positive (see Fig.10)
5	SD0	sensing distance bit 0	reflects actual sensing distance; LSB; note 3; Fig.10
6	SD1	sensing distance bit 1	reflects actual sensing distance; note 3; Fig.10
7	SD2	sensing distance bit 2	reflects actual sensing distance; MSB; note 3; Fig.10
8	P	parity	'high' for even parity: $P = \text{XOR}(\text{data } 0, \text{data } 1 \text{ to data } 7)$

### Notes

1. Air gap reserve: this bit of the protocol indicates that the processed signal amplitude is smaller than twice the minimum allowed signal amplitude (see Fig.10). If this bit is flagged then the air gap is nearly used up, which means that the sensor system will stop working for a further reduction of the signal amplitude.
2. Correct direction recognition is guaranteed for sensing distance: see Chapter "Characteristics".
3. Bits SD0 to SD2: These bits are used to quantify the signal amplitude and therefore the air gap can be divided into 8 sections (see Fig.10). For a temperature sweep over the complete specified range the air gap information may change by 2 LSBs due to the temperature coefficient of the sensor signal amplitude.

Rotational speed sensor for extended air gap application and direction detection

KMI22/1



**Mounting conditions**

The recommended sensor position in front of a gear wheel is shown in Fig.13. The distance 'd' is measured between the sensor front and the tip of a gear wheel tooth. The KMI22/1 senses ferrous indicators like gear wheels in the y direction only (no rotational symmetry of the sensor); see Fig.2. The symmetrical reference axis of the sensor corresponds to the axis of the ferrite magnet.

**Table 4** Gear wheel dimensions

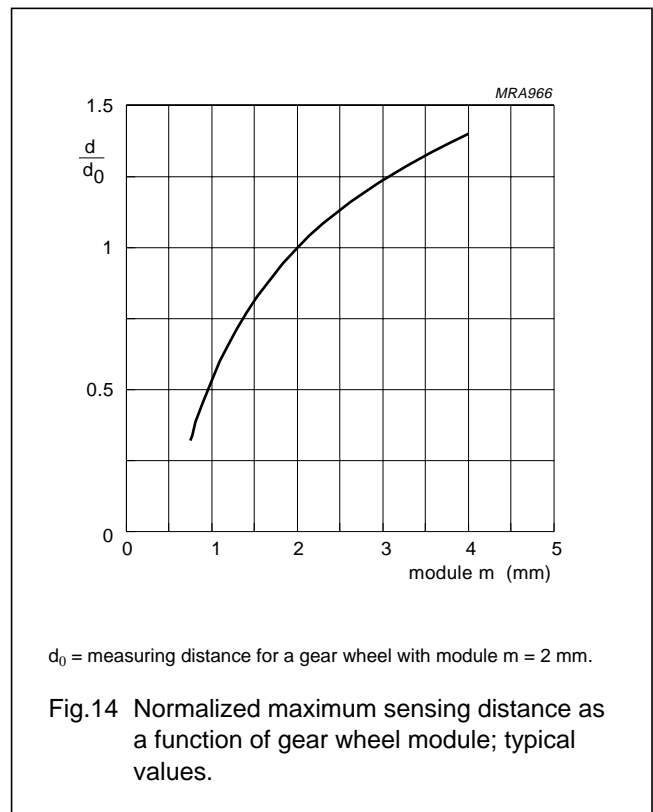
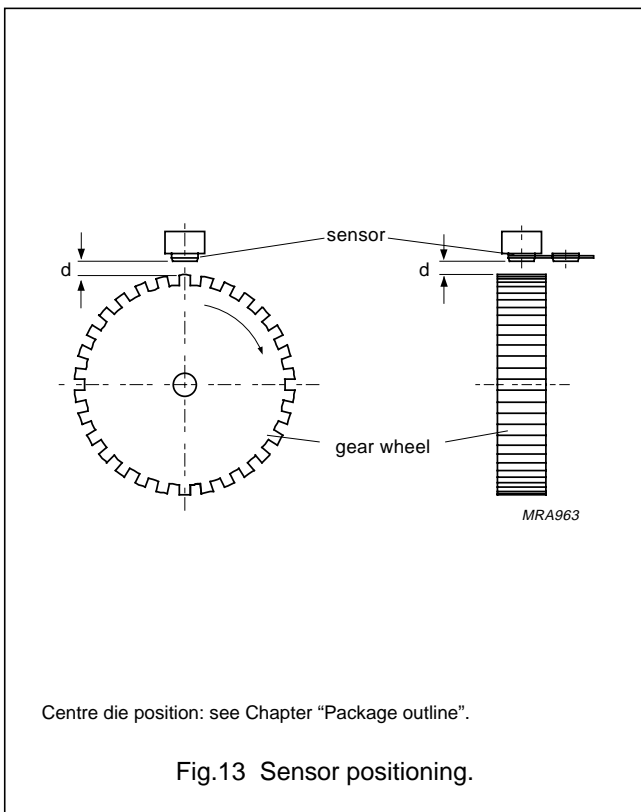
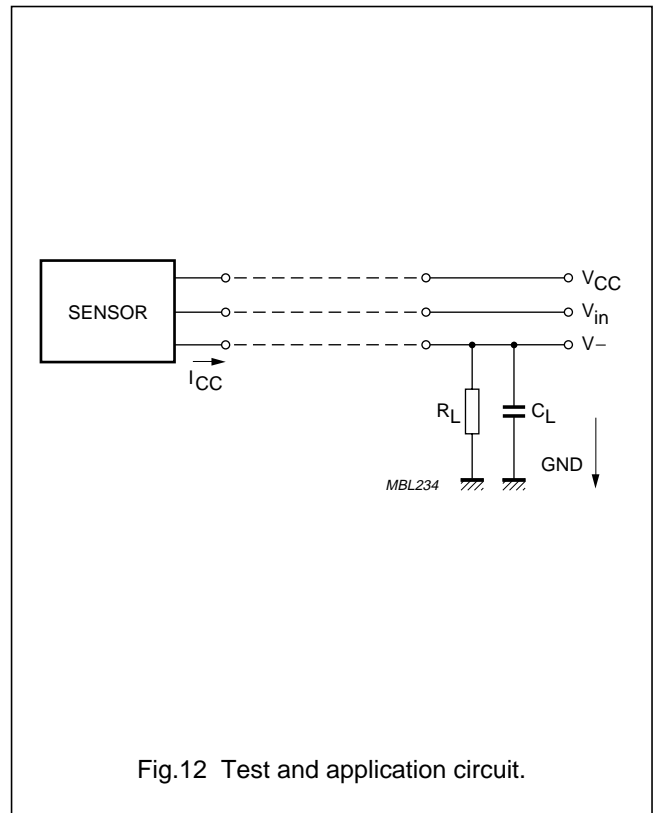
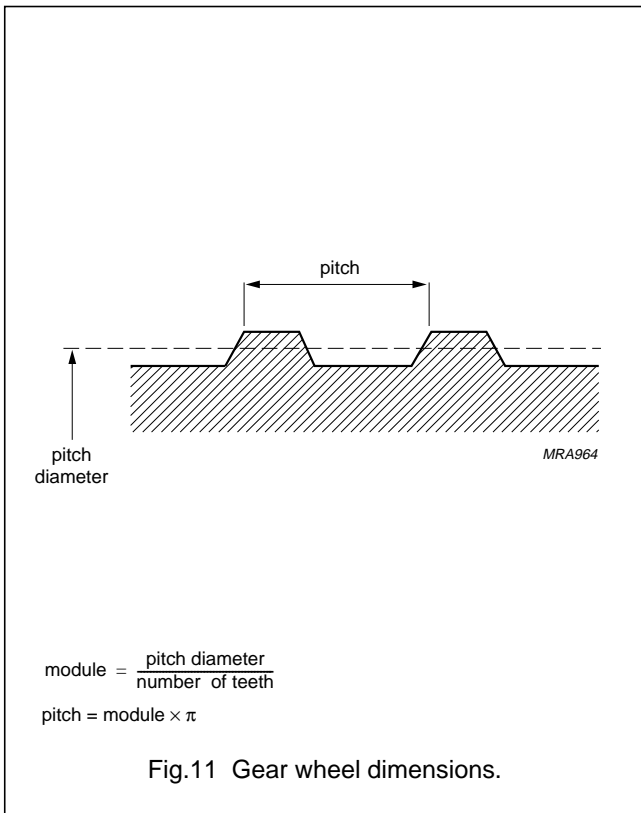
SYMBOL	DESCRIPTION	UNIT
<b>German DIN</b>		
z	number of teeth	
d	diameter	mm
m	module $m = d/z$	mm
p	pitch $\pi = p \times m$	mm
<b>ASA; note 1</b>		
PD	pitch diameter (d in inches)	inch
DP	diametric pitch $DP = z/PD$	inch <sup>-1</sup>
CP	circular pitch $CP = \pi/DP$	inch

**Note**

- For conversion from ASA to DIN:  $m = 25.4 \text{ mm}/DP$ ;  $p = 25.4 \text{ mm} \times CP$ .

# Rotational speed sensor for extended air gap application and direction detection

KMI22/1



# Rotational speed sensor for extended air gap application and direction detection

KMI22/1

## EMC

Figure 15 shows a recommended application circuit for automotive applications. It provides a protection interface to meet Electromagnetic Compatibility (EMC) standards and safeguard against voltage spikes. Table 5 lists the tests which are applicable to this circuit and the achieved class of functional status. Protection against 'load dump' (test pulses 5 according to "DIN 40839") means a very high demand on the protection circuit and requires a suitable suppressor diode with sufficient energy absorption capability.

The board net often contains a central load dump protection that makes such a device in the protection circuit of the sensor module unnecessary.

Tests for electrostatic discharge (ESD) were conducted in line with "IEC 801-2" to demonstrate the KMI22/1's handling capabilities. The "IEC 801-2" test conditions were: C = 150 pF, R = 150 Ω, V = 4 kV.

Electromagnetic disturbances with fields up to 150 V/m and f = 1 GHz (ref. "DIN 40839") have no influence on performance.

**Table 5** EMC test results

EMC REF. DIN 40839	SYMBOL	MIN. (V)	MAX. (V)	REMARKS	CLASS
Test pulse 1	V <sub>LD</sub>	-100	-	t <sub>d</sub> = 2 ms	C
Test pulse 2	V <sub>LD</sub>	-	100	t <sub>d</sub> = 0.2 ms	A
Test pulse 3a	V <sub>LD</sub>	-150	-	t <sub>d</sub> = 0.1 μs	A
Test pulse 3b	V <sub>LD</sub>	-	100	t <sub>d</sub> = 0.1 μs	A
Test pulse 4	V <sub>LD</sub>	-7	-	t <sub>d</sub> = 130 ms	B
Test pulse 5	V <sub>LD</sub>	-	120	t <sub>d</sub> = 400 ms	B

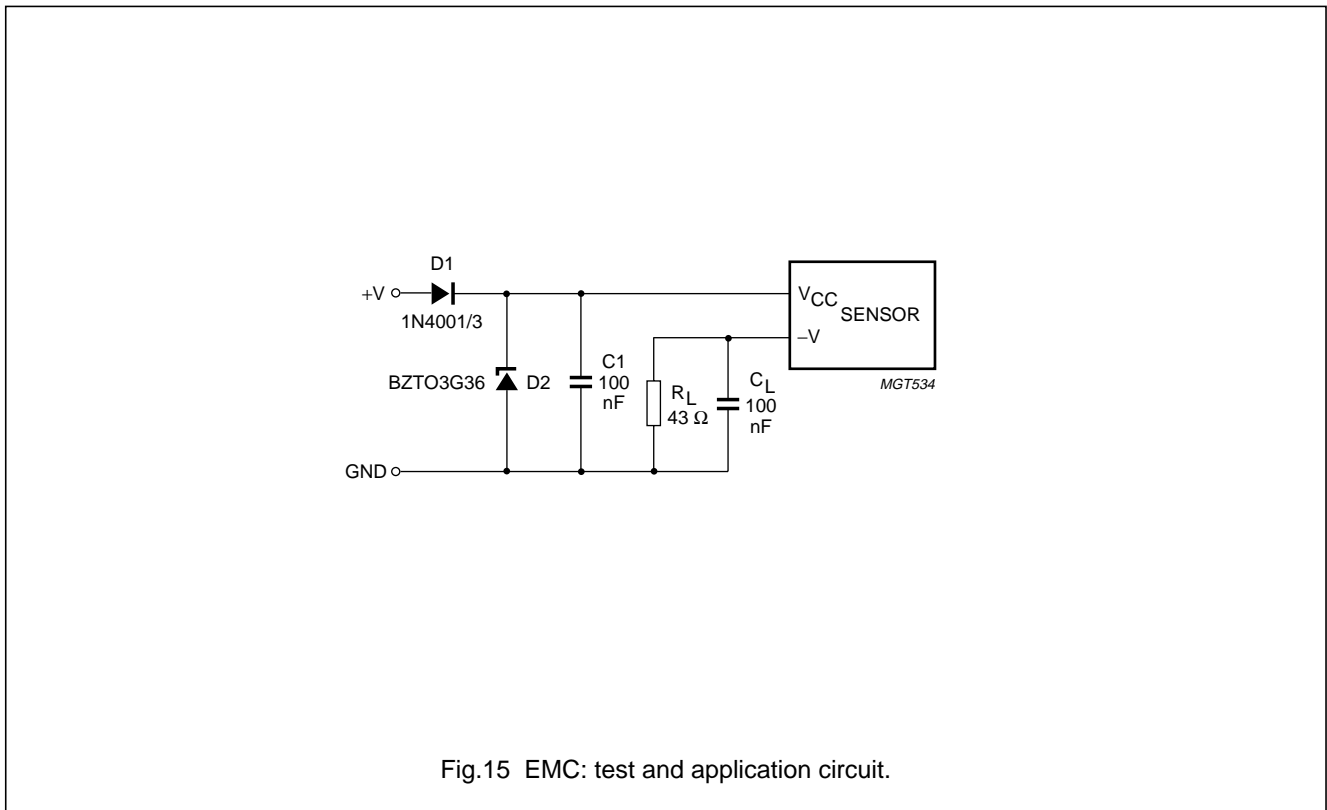


Fig.15 EMC: test and application circuit.

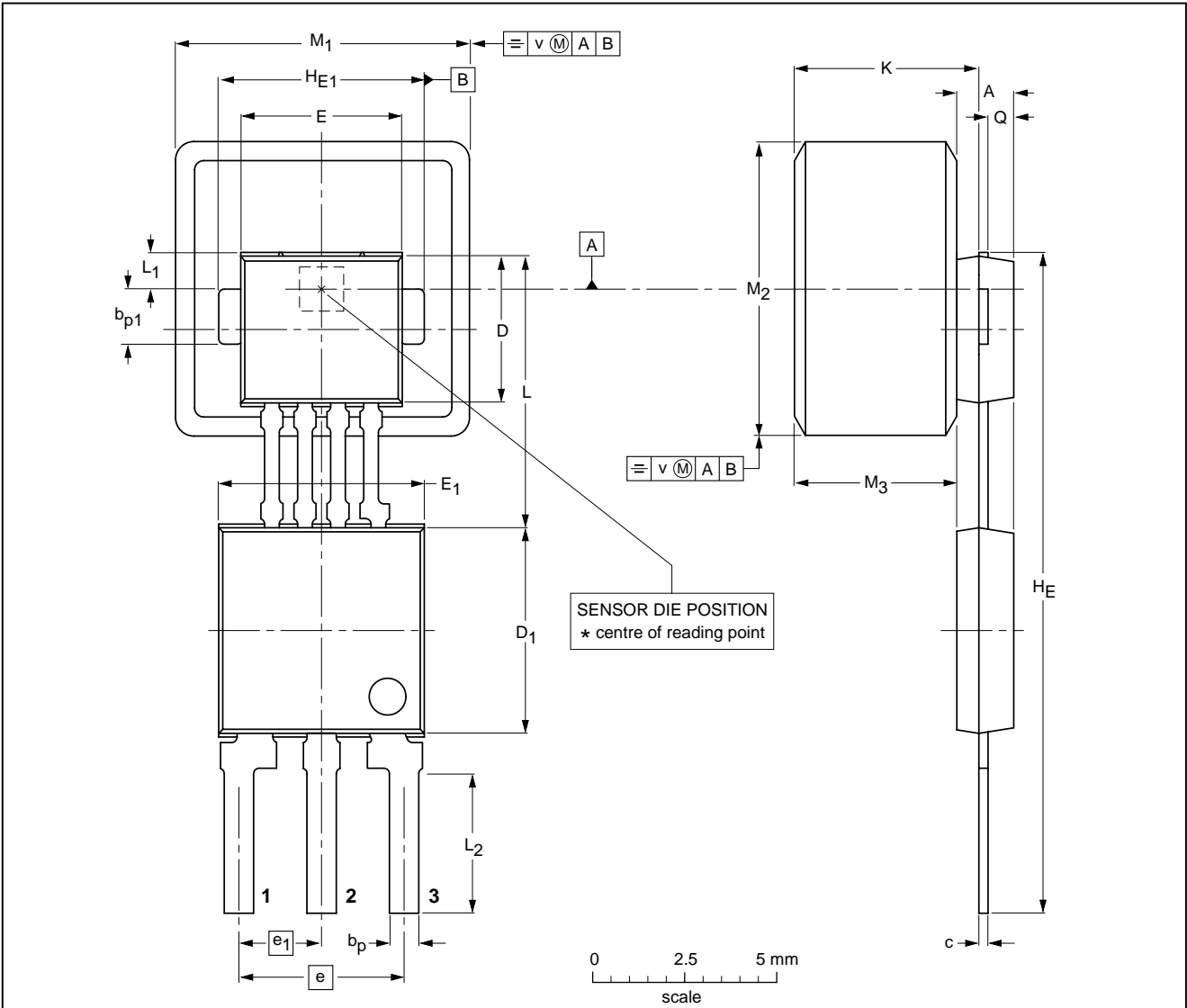
# Rotational speed sensor for extended air gap application and direction detection

KMI22/1

## PACKAGE OUTLINE

Plastic single-ended multi-chip package;  
magnetized ferrite magnet (8 x 8 x 4.5 mm); 4 interconnections; 3 in-line leads

SOT477B



**DIMENSIONS (mm are the original dimensions)**

UNIT	A <sup>(1)</sup>	b <sub>p</sub>	b <sub>p1</sub>	c	D <sup>(2)</sup>	D <sub>1</sub> <sup>(2)</sup>	E <sup>(2)</sup>	E <sub>1</sub> <sup>(2)</sup>	e	e <sub>1</sub>	H <sub>E</sub>	H <sub>E1</sub>	K <sub>max.</sub>	L	L <sub>1</sub>	L <sub>2</sub>	M <sub>1</sub>	M <sub>2</sub>	M <sub>3</sub> <sup>(1)</sup>	Q	v
mm	1.7	0.8	1.57	0.3	4.1	5.7	4.5	5.7	4.6	2.35	18.2	5.6	5.37	7.55	1.2	3.9	8.15	8.15	4.7	0.75	0.25
	1.4	0.7	1.47	0.24	3.9	5.5	4.3	5.5	4.4	2.15	17.8	5.5		7.25	0.9	3.5	7.85	7.85	4.3	0.65	

**Notes**

1. Glue thickness not included.
2. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT477B						99-09-23-00-08-31

# Rotational speed sensor for extended air gap application and direction detection

KMI22/1

## DATA SHEET STATUS

DATA SHEET STATUS	PRODUCT STATUS	DEFINITIONS <sup>(1)</sup>
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

### Note

1. Please consult the most recently issued data sheet before initiating or completing a design.

## DEFINITIONS

**Short-form specification** — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

**Limiting values definition** — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

**Application information** — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

## DISCLAIMERS

**Life support applications** — These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

**Right to make changes** — Philips Semiconductors reserves the right to make changes, without notice, in the products, including circuits, standard cells, and/or software, described or contained herein in order to improve design and/or performance. Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no licence or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

---

Rotational speed sensor for extended air  
gap application and direction detection

---

KMI22/1

**NOTES**

# Philips Semiconductors – a worldwide company

**Argentina:** see South America

**Australia:** 3 Figtree Drive, HOMEBUSH, NSW 2140,  
Tel. +61 2 9704 8141, Fax. +61 2 9704 8139

**Austria:** Computerstr. 6, A-1101 WIEN, P.O. Box 213,  
Tel. +43 1 60 101 1248, Fax. +43 1 60 101 1210

**Belarus:** Hotel Minsk Business Center, Bld. 3, r. 1211, Volodarski Str. 6,  
220050 MINSK, Tel. +375 172 20 0733, Fax. +375 172 20 0773

**Belgium:** see The Netherlands

**Brazil:** see South America

**Bulgaria:** Philips Bulgaria Ltd., Energoproject, 15th floor,  
51 James Bourchier Blvd., 1407 SOFIA,  
Tel. +359 2 68 9211, Fax. +359 2 68 9102

**Canada:** PHILIPS SEMICONDUCTORS/COMPONENTS,  
Tel. +1 800 234 7381, Fax. +1 800 943 0087

**China/Hong Kong:** 501 Hong Kong Industrial Technology Centre,  
72 Tat Chee Avenue, Kowloon Tong, HONG KONG,  
Tel. +852 2319 7888, Fax. +852 2319 7700

**Colombia:** see South America

**Czech Republic:** see Austria

**Denmark:** Sydhavnsgade 23, 1780 COPENHAGEN V,  
Tel. +45 33 29 3333, Fax. +45 33 29 3905

**Finland:** Sinikalliontie 3, FIN-02630 ESPOO,  
Tel. +358 9 615 800, Fax. +358 9 6158 0920

**France:** 51 Rue Carnot, BP317, 92156 SURESNES Cedex,  
Tel. +33 1 4099 6161, Fax. +33 1 4099 6427

**Germany:** Hammerbrookstraße 69, D-20097 HAMBURG,  
Tel. +49 40 2353 60, Fax. +49 40 2353 6300

**Hungary:** see Austria

**India:** Philips INDIA Ltd, Band Box Building, 2nd floor,  
254-D, Dr. Annie Besant Road, Worli, MUMBAI 400 025,  
Tel. +91 22 493 8541, Fax. +91 22 493 0966

**Indonesia:** PT Philips Development Corporation, Semiconductors Division,  
Gedung Philips, Jl. Buncit Raya Kav.99-100, JAKARTA 12510,  
Tel. +62 21 794 0040 ext. 2501, Fax. +62 21 794 0080

**Ireland:** Newstead, Clonskeagh, DUBLIN 14,  
Tel. +353 1 7640 000, Fax. +353 1 7640 200

**Israel:** RAPAC Electronics, 7 Kehilat Saloniki St, PO Box 18053,  
TEL AVIV 61180, Tel. +972 3 645 0444, Fax. +972 3 649 1007

**Italy:** PHILIPS SEMICONDUCTORS, Via Casati, 23 - 20052 MONZA (MI),  
Tel. +39 039 203 6838, Fax +39 039 203 6800

**Japan:** Philips Bldg 13-37, Kohnan 2-chome, Minato-ku,  
TOKYO 108-8507, Tel. +81 3 3740 5130, Fax. +81 3 3740 5057

**Korea:** Philips House, 260-199 Itaewon-dong, Yongsan-ku, SEOUL,  
Tel. +82 2 709 1412, Fax. +82 2 709 1415

**Malaysia:** No. 76 Jalan Universiti, 46200 PETALING JAYA, SELANGOR,  
Tel. +60 3 750 5214, Fax. +60 3 757 4880

**Mexico:** 5900 Gateway East, Suite 200, EL PASO, TEXAS 79905,  
Tel. +9-5 800 234 7381, Fax +9-5 800 943 0087

**Middle East:** see Italy

**Netherlands:** Postbus 90050, 5600 PB EINDHOVEN, Bldg. VB,  
Tel. +31 40 27 82785, Fax. +31 40 27 88399

**New Zealand:** 2 Wagener Place, C.P.O. Box 1041, AUCKLAND,  
Tel. +64 9 849 4160, Fax. +64 9 849 7811

**Norway:** Box 1, Manglerud 0612, OSLO,  
Tel. +47 22 74 8000, Fax. +47 22 74 8341

**Pakistan:** see Singapore

**Philippines:** Philips Semiconductors Philippines Inc.,  
106 Valero St. Salcedo Village, P.O. Box 2108 MCC, MAKATI,  
Metro MANILA, Tel. +63 2 816 6380, Fax. +63 2 817 3474

**Poland:** Al.Jerozolimskie 195 B, 02-222 WARSAW,  
Tel. +48 22 5710 000, Fax. +48 22 5710 001

**Portugal:** see Spain

**Romania:** see Italy

**Russia:** Philips Russia, Ul. Usatcheva 35A, 119048 MOSCOW,  
Tel. +7 095 755 6918, Fax. +7 095 755 6919

**Singapore:** Lorong 1, Toa Payoh, SINGAPORE 319762,  
Tel. +65 350 2538, Fax. +65 251 6500

**Slovakia:** see Austria

**Slovenia:** see Italy

**South Africa:** S.A. PHILIPS Pty Ltd., 195-215 Main Road Martindale,  
2092 JOHANNESBURG, P.O. Box 58088 Newville 2114,  
Tel. +27 11 471 5401, Fax. +27 11 471 5398

**South America:** Al. Vicente Pinzon, 173, 6th floor,  
04547-130 SÃO PAULO, SP, Brazil,  
Tel. +55 11 821 2333, Fax. +55 11 821 2382

**Spain:** Balmes 22, 08007 BARCELONA,  
Tel. +34 93 301 6312, Fax. +34 93 301 4107

**Sweden:** Kottbygatan 7, Akalla, S-16485 STOCKHOLM,  
Tel. +46 8 5985 2000, Fax. +46 8 5985 2745

**Switzerland:** Allmendstrasse 140, CH-8027 ZÜRICH,  
Tel. +41 1 488 2741 Fax. +41 1 488 3263

**Taiwan:** Philips Semiconductors, 5F, No. 96, Chien Kuo N. Rd., Sec. 1,  
TAIPEI, Taiwan Tel. +886 2 2134 2451, Fax. +886 2 2134 2874

**Thailand:** PHILIPS ELECTRONICS (THAILAND) Ltd.,  
60/14 MOO 11, Bangna Trad Road KM. 3, Bagna, BANGKOK 10260,  
Tel. +66 2 361 7910, Fax. +66 2 398 3447

**Turkey:** Yukari Dudullu, Org. San. Blg., 2.Cad. Nr. 28 81260 Umraniye,  
ISTANBUL, Tel. +90 216 522 1500, Fax. +90 216 522 1813

**Ukraine:** PHILIPS UKRAINE, 4 Patrice Lumumba str., Building B, Floor 7,  
252042 KIEV, Tel. +380 44 264 2776, Fax. +380 44 268 0461

**United Kingdom:** Philips Semiconductors Ltd., 276 Bath Road, Hayes,  
MIDDLESEX UB3 5BX, Tel. +44 208 730 5000, Fax. +44 208 754 8421

**United States:** 811 East Arques Avenue, SUNNYVALE, CA 94088-3409,  
Tel. +1 800 234 7381, Fax. +1 800 943 0087

**Uruguay:** see South America

**Vietnam:** see Singapore

**Yugoslavia:** PHILIPS, Trg N. Pasica 5/v, 11000 BEOGRAD,  
Tel. +381 11 3341 299, Fax.+381 11 3342 553

**For all other countries apply to:** Philips Semiconductors,  
Marketing Communications, Building BE-p, P.O. Box 218, 5600 MD EINDHOVEN,  
The Netherlands, Fax. +31 40 27 24825

**Internet:** <http://www.semiconductors.philips.com>

© Philips Electronics N.V. 2000

SCA 70

All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.

The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent- or other industrial or intellectual property rights.

Printed in The Netherlands

613520/01/pp16

Date of release: 2000 Sep 04

Document order number: 9397 750 07247

*Let's make things better.*

**Philips**  
Semiconductors



**PHILIPS**